# Engineering Development Model

# **RF Transformer**

# T9-ED10543/2

Impedance Ratio: 9

#### **Important Note**

This model has been designed, built and tested in our engineering department. Performance data represents model capability. At present it is a non-catalog model. On request, we can supply a final specification sheet, part number and price/delivery information.



Please click "Back", and then click "Contact Us" for Applications support.

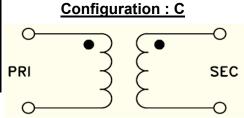
**CASE STYLE: KK81** 

	ELECTRICAL SPECI	FICATIONS 50	Ω @ +25°C		
Parameter		Min.	Тур.	Max.	Units
Frequency		2.5		280	MHz
Insertion Loss *	3 dB Bandwidth		2.5 - 280		MHz
	2 dB Bandwidth		4.5 - 200		MHz
	1 dB Bandwidth		20 - 140		MHz

#### Notes:

<sup>\*</sup> Insertion Loss is referenced to mid-band loss, 0.52dB typ.

MAXIMUM RATINGS				
Operating Temperature	-20°C to 85°C			
Storage Temperature	-55°C to 100°C			
RF Power	0.25 W			
DC Current	30 mA			



PIN CONNECTIONS					
PRIMARY DOT	4				
PRIMARY	6				
SECONDARY DOT	3				
SECONDARY	1				
NOT USED	2,5				

# Typical Performance Data

INSERTION LOSS (dB)	RETURN LOSS (dB)
3 15	4.25
	4.91
	6.26
	7.49
	8.64
	9.71
	10.68
	11.57
	13.08
	14.31
	15.31
	16.15
	16.87
	21.31
	24.68
	23.32
	20.82
	18.63
	17.83
	17.07
	16.88
	16.71
	15.84
	15.05
	14.67
	14.31
	13.96
	13.60
	11.18
	9.20
	7.59
	6.29
	5.27



# Typical Performance Data



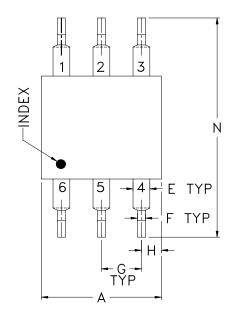




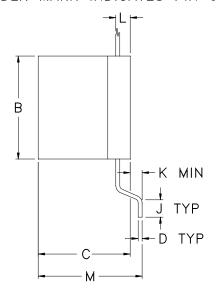


## **KK81** KK265

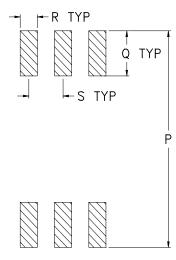
## **Outline Dimensions**



NOTE: PIN NUMBERS DO NOT APPEAR ON UNIT, FOR REFERENCE ONLY INDEX MARK INDICATES PIN 6.



### **PCB Land Pattern**



Suggested Layout, Tolerance to be within  $\pm .002$ 

CASE#	A	В	C	D	Е	F	G	Н	J	K	L	M	N	P
KK81	.30	.27	.23	.010	0.42	.020	.100	.05	.05	.020	.036	.26	.575	.600
	(7.62)	(6.86)	(5.84)	(0.25)	(1.07)	(0.51)	(2.54)	(1.27)	(1.27)	(0.51)	(0.91)	(6.60)	(14.61)	(15.24)
KK265	.30	.27	.22	.010	.020	.020	.100	.05	.05	0.1	.032	.23	.450	.475
	(7.62)	(6.86)	(5.84)	(0.25)	(0.50)	(0.51)	(2.54)	(1.27)	(1.27)	(0.25)	(0.81)	(5.84)	(10.62)	(12.07)

CASE#	Q	R	S	WT. GRAM
KK81	.125 (3.18)	.050 (1.27)	.100 (2.54)	.50
KK265	.125 (3.18)	.050 (1.27)	.100 (2.54)	.65

Dimensions are in inches (mm). Tolerances: 2 Pl. ± .03; 3 Pl. ± .015

#### **Notes:**

1. Case material: Plastic.

2. Termination finish:

For RoHS Case Styles: Tin plate over Nickel plate.

For RoHS-5 Case Styles: Tin-Lead plate.

3. Special Tolerances: Termination width  $\pm$  .005 inch, termination thickness  $\pm$  .003 inch.



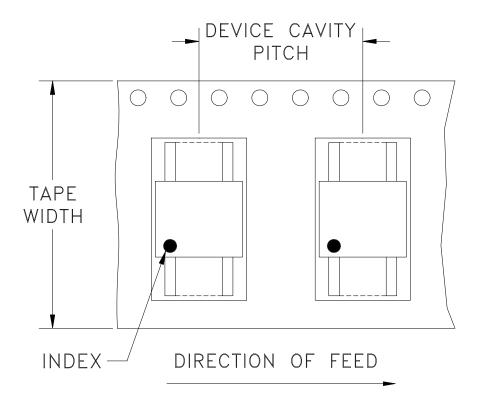
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# Tape & Reel Packaging TR-F1

## DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel
24	12	13	900

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

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#### **Environmental Specifications**

**ENV19** 

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Lead Integrity	2 Pound Pull, perpendicular to edge of unit	MIL-STD-202, Method 211, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215

ENV19 Rev: A

03/09/11

M131005 File: ENV19.pdf

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